IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for half bridge resonant applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb-Free Devices

Typical Applications

- Inductive Heating
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	80 40	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	200	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	l _F 80 40	
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	200	A
Gate-emitter voltage	V_{GE}	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	250 50	W
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

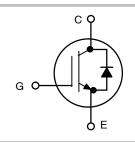
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

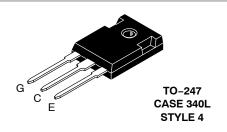


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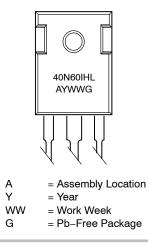
http://onsemi.com

40 A, 600 V V_{CEsat} = 2.0 V E_{off} = 0.4 mJ





MARKING DIAGRAM



ORDERING INFORMATION

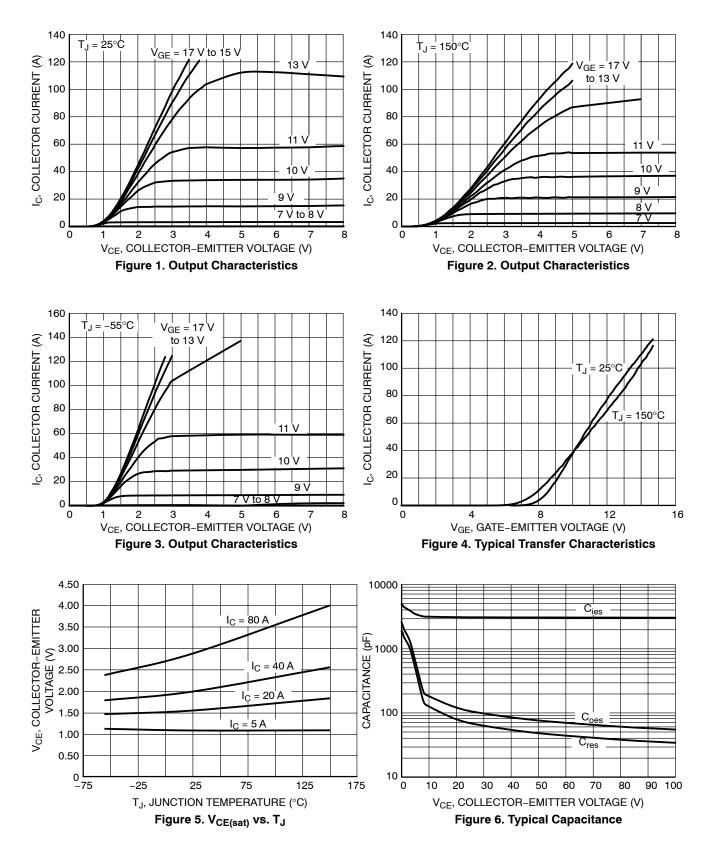
Device	Package	Shipping
NGTB40N60IHLWG	TO-247 (Pb-Free)	30 Units / Rail

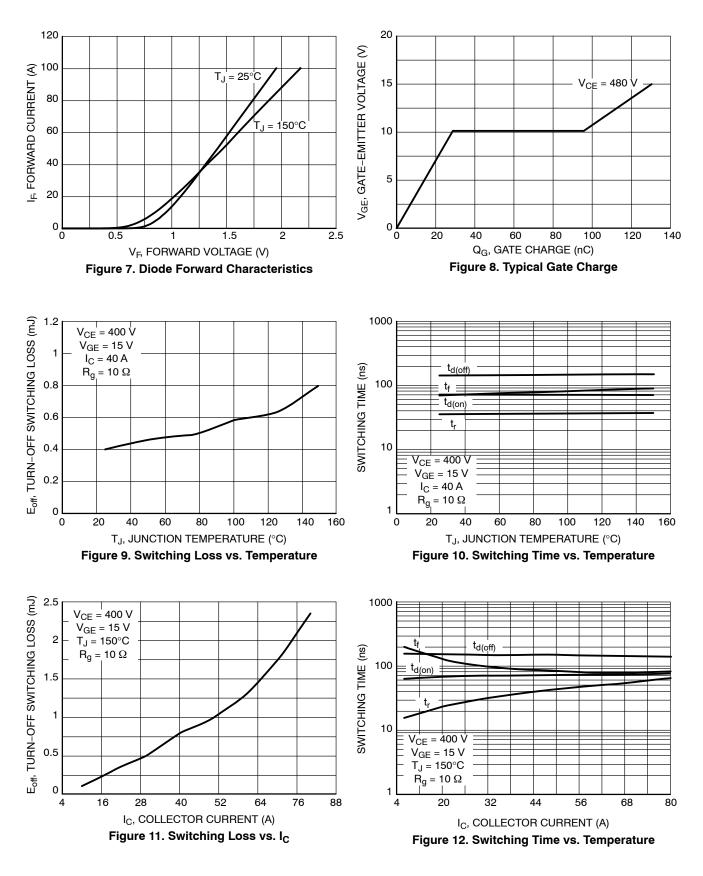
THERMAL CHARACTERISTICS

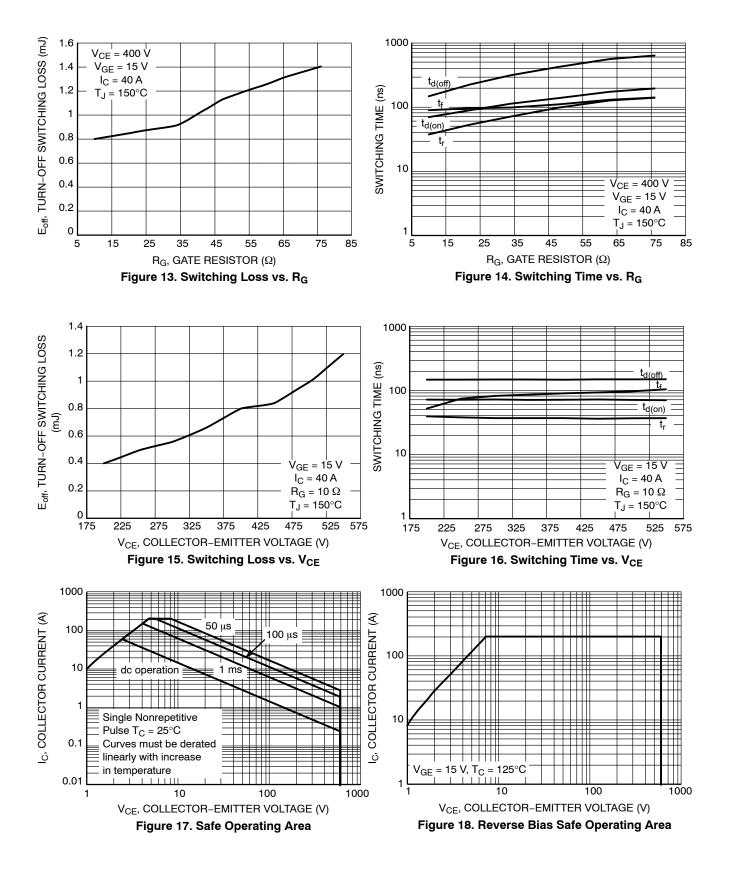
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.87	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.46	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•					
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	600	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V_{GE} = 15 V, I _C = 40 A, T _J = 150°C	V _{CEsat}	_	2.0 2.6	2.4 _	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 150 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$ $V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}, T_{J} = 150^{\circ}\text{C}$	I _{CES}	_		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC	•					
Input capacitance		C _{ies}	-	3100	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	120	-	
Reverse transfer capacitance		C _{res}	-	80	-	
Gate charge total		Qg		130		nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}		29		
Gate to collector charge		Q _{gc}		67		
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}		70		ns
Rise time	T _J = 25°C	t _r		40		
Turn-off delay time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{q} = 10 \Omega$	t _{d(off)}		140		
Fall time	$V_{GE} = 0 \text{ V}/15 \text{V}$	t _f		70		
Turn-off switching loss		E _{off}		0.4		mJ
Turn-on delay time		t _{d(on)}		70		ns
Rise time	T _J = 150°C	t _r		40		
Turn-off delay time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{q} = 10 \Omega$	t _{d(off)}		140		
Fall time	V _{GE} = 0 V/ 15V	t _f		90		
Turn-off switching loss		E _{off}		0.8		mJ
DIODE CHARACTERISTIC						
Forward voltage	$\label{eq:VGE} \begin{array}{l} V_{GE} = 0 \ \text{V}, \ \text{I}_{F} = 40 \ \text{A} \\ V_{GE} = 0 \ \text{V}, \ \text{I}_{F} = 40 \ \text{A}, \ \text{T}_{J} = 150^{\circ}\text{C} \end{array}$	V _F		1.3 1.35	1.5	V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}		400		ns
Reverse recovery charge	I _F = 40 Å, V _R = 200 V di _F /dt = 200 A/μs	Q _{rr}		5500		nc
Reverse recovery current		I _{rrm}		25		А







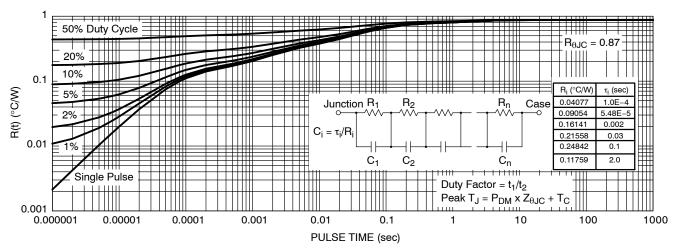


Figure 19. IGBT Transient Thermal Impedance

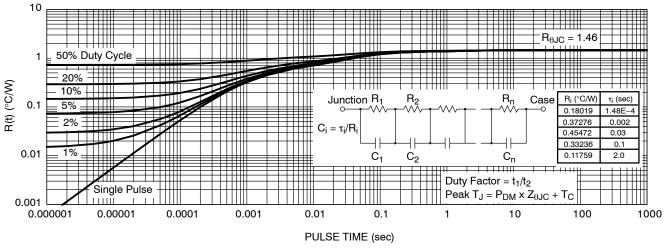


Figure 20. Diode Transient Thermal Impedance

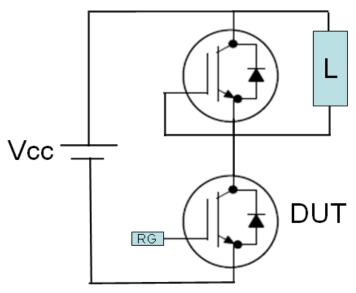
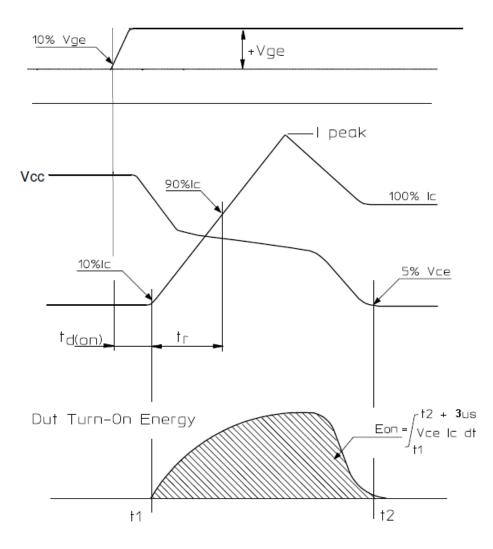
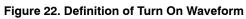


Figure 21. Test Circuit for Switching Characteristics





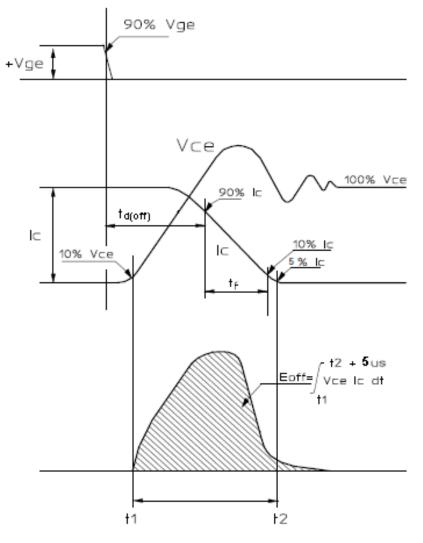
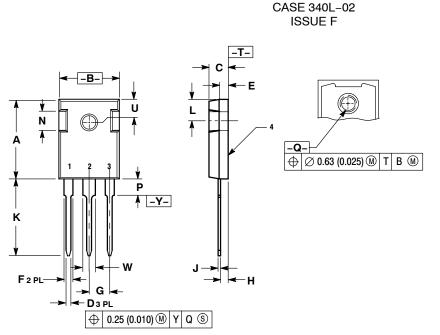


Figure 23. Definition of Turn Off Waveform

PACKAGE DIMENSIONS

TO-247



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. MILLIMETERS INCHES DIM MIN MAX MIN MAX

	INTEENIETEITO		INCILO		
DIM	MIN	MAX	MIN	MAX	
Α	20.32	21.08	0.800	8.30	
В	15.75	16.26	0.620	0.640	
С	4.70	5.30	0.185	0.209	
D	1.00	1.40	0.040	0.055	
Е	1.90	2.60	0.075	0.102	
F	1.65	2.13	0.065	0.084	
G	5.45 BSC		0.215	BSC	
Н	1.50	2.49	0.059	0.098	
J	0.40	0.80	0.016	0.031	
K	19.81	20.83	0.780	0.820	
L	5.40	6.20	0.212	0.244	
Ν	4.32	5.49	0.170	0.216	
Р		4.50		0.177	
Q	3.55	3.65	0.140	0.144	
U	6.15	BSC	0.242 BSC		
W	2.87	3.12	0.113	0.123	

STYLE 4:

PIN 1. GATE 2. COLLECTOR 3. EMITTER

4. COLLECTOR

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